

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	3.0	А	8/20µs, Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	-	—	5.5	V	—
Reverse Current (Note 6)	I _R	-	—	200	nA	$V_R = 5.5V$
Reverse Breakdown Voltage	V _{BR}	6.0	_	_	V	I _R = 1mA
Reverse Clamping Voltage, Positive Transients (Note 7)	V _{CL}	_	10	12	V	$I_{PP} = 1A, t_p = 8/20 \mu s$
Dynamic Resistance	R _{DYN}	_	1.0	_	Ω	$I_{R} = 1A, t_{p} = 8/20 \mu s$
Capacitance (Note 8)	0	_	0.4	0.65	pF	V _R = 2.5V, f = 1MHz
Capacitance (Note 8)	CT	—	0.5	—	pF	$V_R = 0V, f = 1MHz$

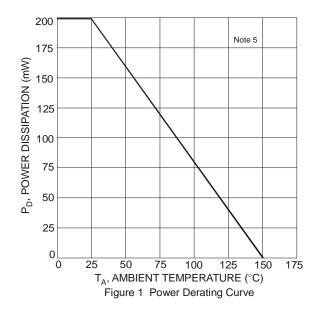
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

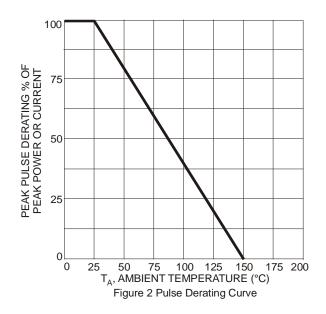
6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an $8x20\mu s$ peak pulse current (I_pp) waveform.

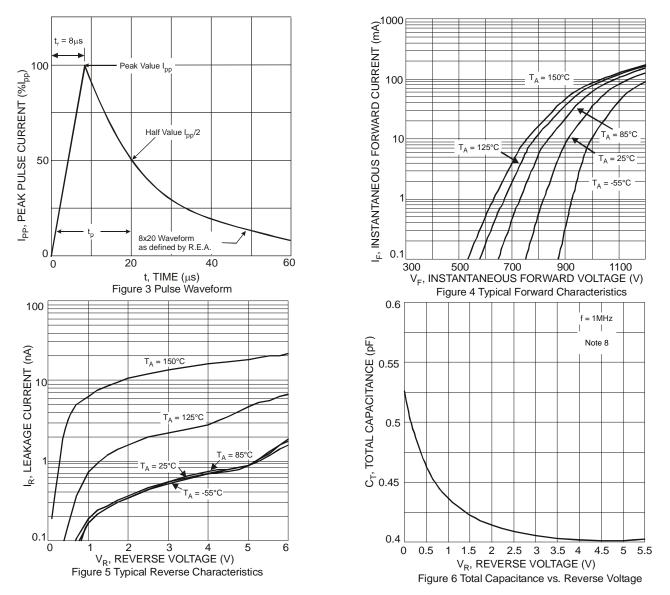
8. Measured from any CH to GND.

9. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.



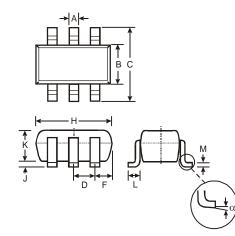






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

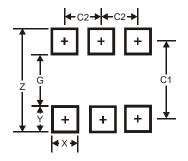


SOT363				
Dim	Min	Max	Тур	
Α	0.10	0.30	0.25	
В	1.15	1.35	1.30	
С	2.00	2.20	2.10	
D	0.65 Тур			
F	0.40	0.45	0.425	
Н	1.80	2.20	2.15	
J	0	0.10	0.05	
κ	0.90	1.00	1.00	
L	0.25	0.40	0.30	
Μ	0.10	0.22	0.11	
α	0°	8°	-	
All Dimensions in mm				



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65

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